PROCEEDINGS OF SPIE

Image Sensing Technologies: Materials, Devices, Systems, and Applications VI

Nibir K. Dhar Achyut K. Dutta Sachidananda R. Babu Editors

15–16 April 2019 Baltimore, Maryland, United States

Sponsored and Published by SPIE

Volume 10980

Proceedings of SPIE 0277-786X, V. 10980

SPIE is an international society advancing an interdisciplinary approach to the science and application of light.

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Author(s), "Title of Paper," in Image Sensing Technologies: Materials, Devices, Systems, and Applications VI, edited by Nibir K. Dhar, Achyut K. Dutta, Sachidananda R. Babu, Proceedings of SPIE Vol. 10980 (SPIE, Bellingham, WA, 2019) Seven-digit Article CID Number.

ISSN: 0277-786X ISSN: 1996-756X (electronic)

ISBN: 9781510626256 ISBN: 9781510626263 (electronic)

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